



1775-4
C.C.
566.40595X00

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicants: H. TANEI, et al.
Serial No.: 09/941,988
Filed: August 30, 2001
For: ELECTRONIC COMPONENT AND METHOD
OF MANUFACTURING THE SAME
Group: 1775
Examiner: Gwendolyn A. Blackwell Rudasil

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AMENDMENT

Assistant Commissioner for Patents
Washington, D.C. 20231

February 14, 2003

Sir:

In response to the Office Action mailed November 14, 2002, please amend
the above-identified application as follows:

IN THE CLAIMS:

Please amend the claims presently in the application as follows:

4. (Amended) An electronic component which has a conductor film formed
on a glass ceramic board, formed by a method comprising the steps of:

B1
sticking a conductor paste containing a silver particle having a specific
surface area of $0.3\text{m}^2/\text{g}$ to $3.0\text{m}^2/\text{g}$ and no glass onto a glass ceramic sheet board
which has not been sintered or has been sintered; and

firing the conductor paste at a temperature having a difference of $\pm 50^\circ\text{C}$ from
a softening temperature of the glass of the glass ceramic board and for forming the
conductor film on the glass ceramic board.